

**RESPONSE UNDER 37 C.F.R. § 1.116
EXPEDITED PROCEDURE
GROUP ART UNIT 1795**

Docket Number
36856.1455

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Hiroyuki KANBARA et al.	Art Unit: 1795
Application No.: 10/596,000	
Confirmation No.: 1561	Examiner: A. Eoff
Filing or 371(c) Date: January 17, 2007	
Title: METHOD FOR FORMING THICK FILM PATTERN, METHOD FOR MANUFACTURING ELECTRONIC COMPONENT AND PHOTOLITHOGRAPHY PHOTOSENSITIVE PASTE	

AMENDMENT

DO NOT ENTER: /A.E./

07/07/2008

Entered with R.R. 7/29/08
MW 7/3/09

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated April 2, 2008, please amend the above-identified application as follows:

- Amendments to the Specification** begin on page _____ of this paper.
- Amendments to the Claims** are reflected in the listing of the claims which begins on page 2 of this paper.
- Amendments to the Drawings** begin on page _____ of this paper and include an attached replacement sheet. An **Appendix** including the amended drawing figures is attached following page _____ of this paper.
- Remarks/Arguments** begin on page 6 of this paper.

Please note, if a box is not checked, then no corresponding amendment is being made.